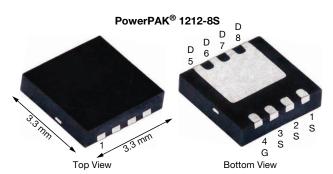


www.vishay.com

Vishay Siliconix

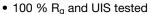
P-Channel 30 V (D-S) MOSFET



PRODUCT SUMMARY					
V _{DS} (V)	-30				
$R_{DS(on)}$ max. (Ω) at V_{GS} = -10 V	0.0051				
$R_{DS(on)}$ max. (Ω) at $V_{GS} = -6 \text{ V}$	0.0068				
$R_{DS(on)}$ max. (Ω) at $V_{GS} = -4.5 \text{ V}$	0.0081				
Q _g typ. (nC)	36.6				
I _D (A) ^{a, g}	-50				
Configuration	Single				

FEATURES

- TrenchFET® Gen III p-channel power MOSFET
- Low thermal resistance PowerPAK[®] package with small size and low 0.75 mm profile



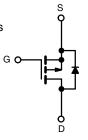
· Material categorization: for definitions of compliance please see www.vishav.com/doc?99912



RoHS COMPLIANT HALOGEN **FREE**

APPLICATIONS

- Battery management in mobile devices
- · Adapter and charger switch
- · Battery switch
- · Load switch



P-Channel MOSFET

ORDERING INFORMATION	
Package	PowerPAK 1212-8S
Lead (Pb)-free and halogen-free	SiSS27ADN-T1-GE3

ABSOLUTE MAXIMUM RATING	3S (T _A = 25 °C, u	ınless other	wise noted)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V_{DS}	-30	V	
Gate-source voltage		V_{GS}	± 20		
	T _C = 25 °C		-50 a		
Ossilia as a daria a susal (T	T _C = 70 °C	1 .	-50 a	1	
Continuous drain current (T _J = xx °C)	T _A = 25 °C	I _D	-24.3 b, c	Ī	
	T _A = 70 °C		-19.4 ^{b, c}	1 ,	
Pulsed drain current (t = 100 µs)		I _{DM}	-200	A	
Continuous durin dinda aument	T _C = 25 °C		-47.5	Ī	
Continuous source-drain diode current	T _A = 25 °C	l _S	-4 b, c	1	
Single pulse avalanche current	l 0.1 mll	I _{AS}	-25	Ī	
Single pulse avalanche current L = 0.1 mF		E _{AS}	31	mJ	
	T _C = 25 °C		57		
Manian and a sure discipation	T _C = 70 °C	36	W		
Maximum power dissipation	T _A = 25 °C	P _D	4.8 b, c	T VV	
	T _A = 70 °C	1	3.1 b, c	1	
Operating junction and storage temperature range		T _J , T _{stq}	-55 to +150	°C	
Soldering recommendations (peak temperature) d, e		1	260]	

THERMAL RESISTANCE RATING	S				
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient b, f	t ≤ 10 s	R _{thJA}	21	26	°C/W
Maximum junction-to-case (drain)	Steady state	R _{thJC}	1.7	2.2	C/VV

Notes

- a. Package limited.
- b. Surface mounted on 1" x 1" FR4 board.
- t = 10 s.
- See solder profile (www.vishay.com/doc?73257). The PowerPAK 1212-8S is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- Rework conditions: manual soldering with a soldering iron is not recommended for leadless components. Maximum under steady state conditions is 63 °C/W.
- g. $T_C = 25$ °C.

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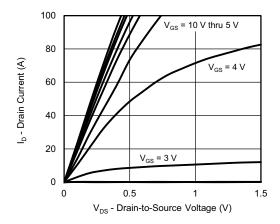
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static						
Drain-source breakdown voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	-30	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	J 050 A	-	-20.6	-	
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = -250 μA	-	5	-	mV/°C
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = -250 \mu A$	-1	-	-2.2	V
Gate-source leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA
Zava gata valtaga drain avvent		V _{DS} = -30 V, V _{GS} = 0 V	-	-	-1	
Zero gate voltage drain current	I _{DSS}	V _{DS} = -30 V, V _{GS} = 0 V, T _J = 70 °C	-	-	-10	μA
On-state drain current a	I _{D(on)}	$V_{DS} \ge -10 \text{ V}, V_{GS} = -10 \text{ V}$	-30	-	-	Α
		V _{GS} = -10 V, I _D = -15 A	-	0.0042	0.0051	
Drain-source on-state resistance a	R _{DS(on)}	V _{GS} = -6 V, I _D = -10 A	-	0.0056	0.0068	Ω
		$V_{GS} = -4.5 \text{ V}, I_D = -5 \text{ A}$	-	0.0067	0.0081	
Forward transconductance a	9 _{fs}	V _{DS} = -16 V, I _D = -15 A	-	57	-	S
Dynamic ^b						
Input capacitance	C _{iss}		-	4660	-	
Output capacitance	Coss	V _{DS} = -15 V, V _{GS} = 0 V, f = 1 MHz	-	502	-	рF
Reverse transfer capacitance	C _{rss}	-		440	-	1
Table at a share	0	$V_{DS} = -15 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -24.3 \text{ A}$	-	77.5	117	
Total gate charge	Q_g		-	36.6	55	0
Gate-source charge	Q_{gs}	$V_{DS} = -15 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -24.3 \text{ A}$	-	11.8	-	nC
Gate-drain charge	Q_{gd}]	-	11.4	-	1
Gate resistance	Rg	f = 1 MHz	0.6	3	6	Ω
Turn-on delay time	t _{d(on)}		-	48	72	
Rise time	t _r	$V_{DD} = -15 \text{ V}, R_L = 0.77 \Omega, I_D \cong -19.4 \text{ A},$	-	35	42	1
Turn-off delay time	t _{d(off)}	V_{GEN} = -4.5 V, R_g = 1 Ω	-	38	46	1
Fall time	t _f]	-	22	33	1
Turn-on delay time	t _{d(on)}		-	12	18	ns
Rise time	t _r	$V_{DD} = -15 \text{ V}, R_L = 0.77 \Omega, I_D \cong -19.4 \text{ A},$	-	18	27	1
Turn-off delay time	t _{d(off)}	V_{GEN} = -10 V, R_g = 1 Ω	-	60	75	1
Fall time	t _f]	-	18	27	
Drain-Source Body Diode Characteristi	cs					
Continuous source-drain diode current	I _S	T _C = 25 °C	-	-	-50	
Pulse diode forward current	I _{SM}		-	-	-200	A
Body diode voltage	V_{SD}	I _S = -19.4 A, V _{GS} = 0 V	-	-0.8	-1.2	V
Body diode reverse recovery time	t _{rr}		-	40	60	ns
Body diode reverse recovery charge	Q _{rr}	1 40.44 41/41 400.47 7 5-00	-	22	33	nC
Reverse recovery fall time	ta			18	-	
Reverse recovery rise time	t _b	1	_	18	-	ns

Notes

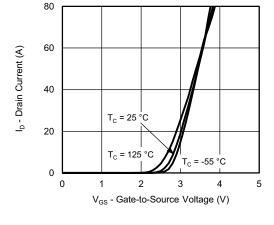
- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

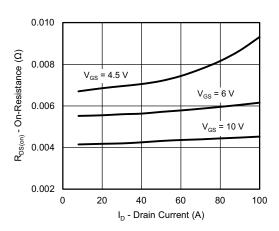




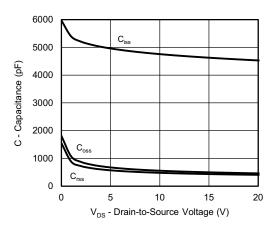
Output Characteristics



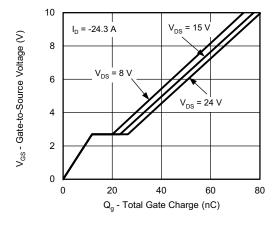
Transfer Characteristics



On-Resistance vs. Drain Current and Gate Voltage

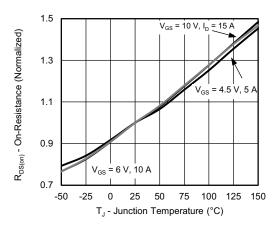


Capacitance

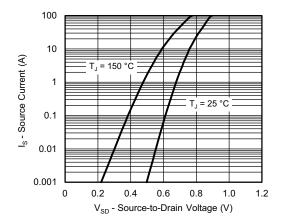


Gate Charge

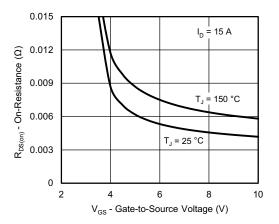
On-Resistance vs. Junction Temperature



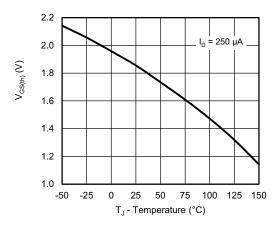




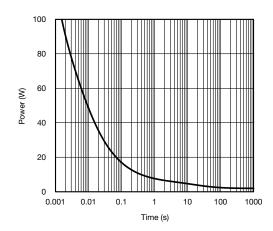
Source-Drain Diode Forward Voltage



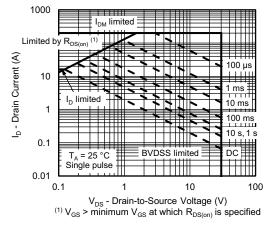
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage

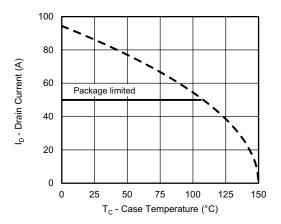


Single Pulse Power, Junction-to-Ambient

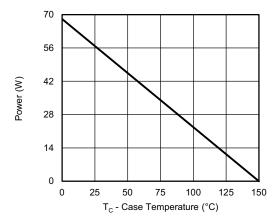


Safe Operating Area, Junction-to-Ambient

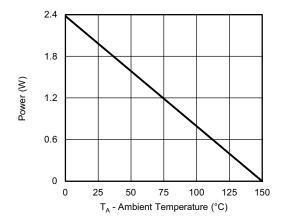




Current Derating a





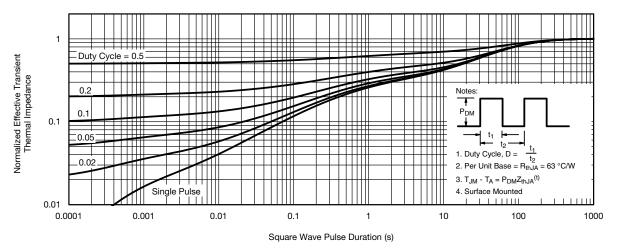


Power, Junction-to-Ambient

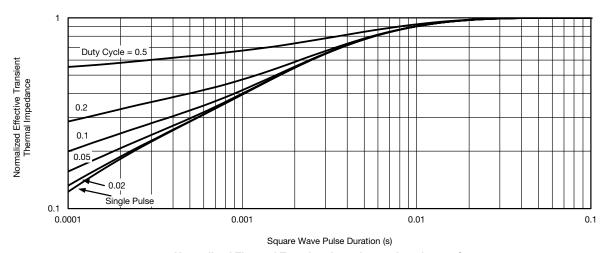
Note

a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?75459.



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Case Outline for PowerPAK® 1212-8S





DIM.		MILLIMETERS			INCHES	
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
Α	0.67	0.75	0.83	0.026	0.030	0.033
A1	0.00	-	0.05	0.000	-	0.002
A3		0.20 ref.			0.008 ref	
b	0.25	0.30	0.35	0.010	0.012	0.014
D	3.20	3.30	3.40	0.126	0.130	0.134
D1	2.15	2.25	2.35	0.085	0.089	0.093
E	3.20	3.30	3.40	0.126	0.130	0.134
E1	1.60	1.70	1.80	0.063	0.067	0.071
е		0.65 bsc.			0.026 bsc.	
K		0.76 ref.			0.030 ref.	
K1	0.41 ref.			0.41 ref. 0.016 ref.		
L	0.33	0.43	0.53	0.013	0.017	0.021
Z	0.525 ref.				0.021 ref.	

ECN: C20-0862-Rev. B, 20-Jul-2020

DWG: 6008



RECOMMENDED MINIMUM PADS FOR PowerPAK® 1212-8 Single



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE



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